

PRELIMINARY SPEC

Part Number: KT-2520SY9ZS-RV

Super Bright Yellow

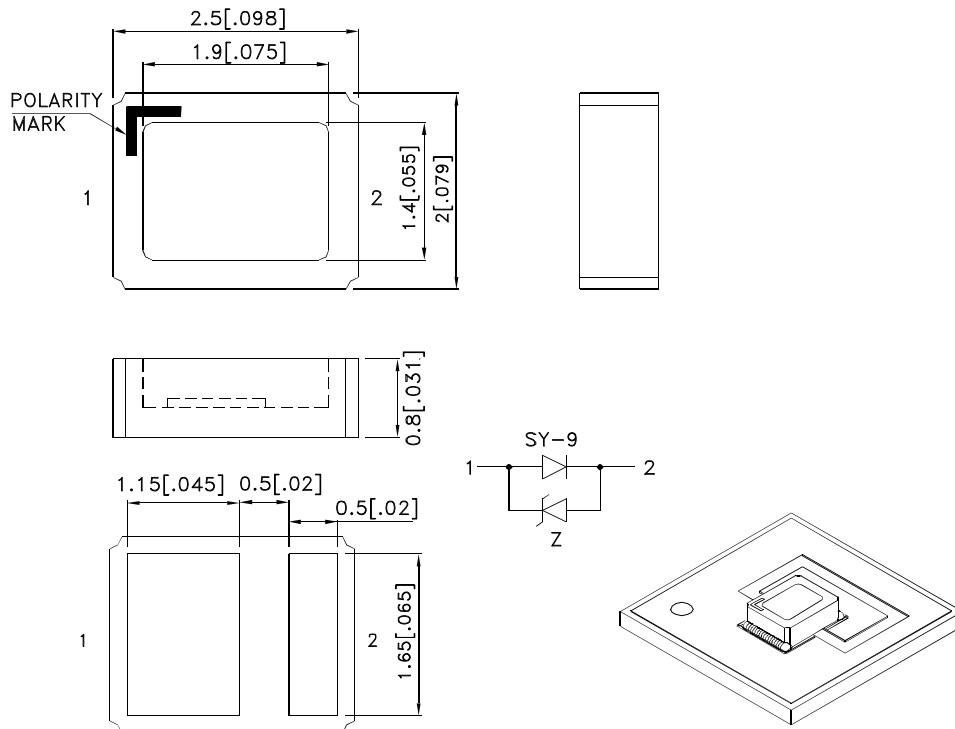
Features

- Dimension: 2.5mm x 2.0mm x 0.8mm.
- Low thermal resistance.
- Ceramic package with silicone resin.
- Small package with high efficiency.
- Surface mount technology.
- ESD protection.
- Package : 2000pcs / reel.
- Moisture sensitivity level : level 2a.
- Soldering methods: IR reflow soldering.
- RoHS compliant.

Typical Applications

- PDA's
- Room lighting
- Architectural lighting
- Decorative/pathway lighting
- Front panel backlight
- Exterior automotive lighting:
(brake lights, turn lights, backlighting)

Package Dimensions



Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01)$ " unless otherwise noted.
3. Specifications are subject to change without notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.

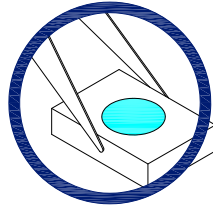


Handling Precautions

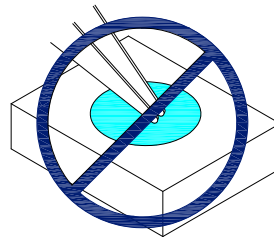
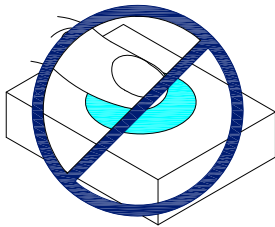
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of the LED.

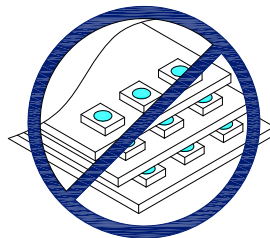
1. Handle the component along the side surfaces by using forceps or appropriate tools.



2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.



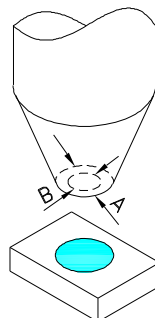
3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



4. The outer diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.

5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.

6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



Selection Guide

Part No.	Dice	luminous Intensity [2] Iv(mcd)@ 350mA		Φ_v (lm) [2] @ 350mA	Viewing Angle [1]
		Min.	Typ.	Typ.	2 θ 1/2
KT-2520SY9ZS-RV	Super Bright Yellow (InGaAlP)	4700	7000	16	130 °

Notes:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
2. Luminous intensity/ Luminous Flux: +/-15%.

Absolute Maximum Ratings at T_A = 25°C

Parameter	Symbol	Value	Unit
DC Forward Current [1]	I _F	350	mA
Peak Forward Current [2]	I _{FM}	500	mA
Power dissipation	P _t	0.98	W
Operating Temperature	T _{op}	-40 To +100	°C
Storage Temperature	T _{stg}	-40 To +120	°C
Junction temperature[1]	T _J	120	°C
Thermal resistance [1] (Junction/ambient)	R _{th j-a}	105	°C/W
Thermal resistance [1] (Junction/solder point)	R _{th j-s}	31	°C/W
Electrostatic Discharge Threshold (HBM)		8000	V

Notes:

1. Results from mounting on PC board FR4, mounted on pc board-metal core PCB is recommend for lowest thermal resistance.
2. 1/10 Duty Cycle, 0.1ms Pulse Width.

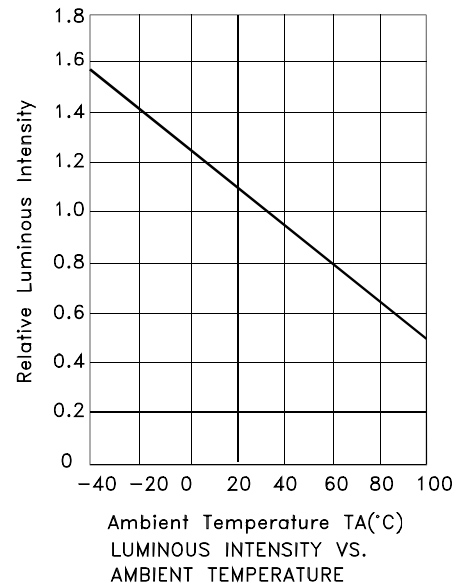
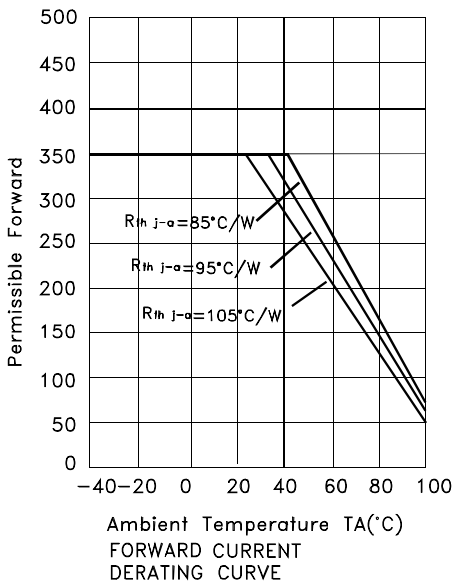
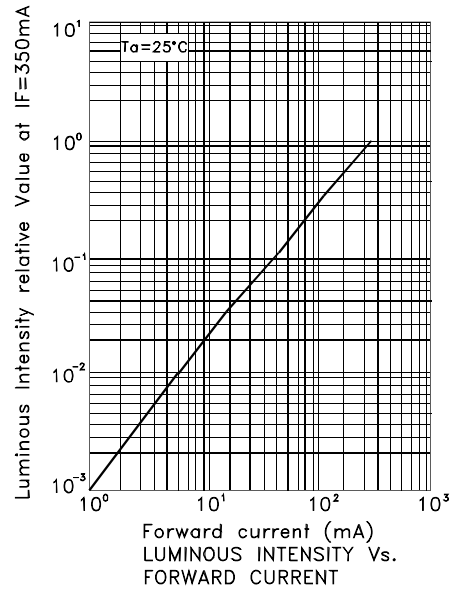
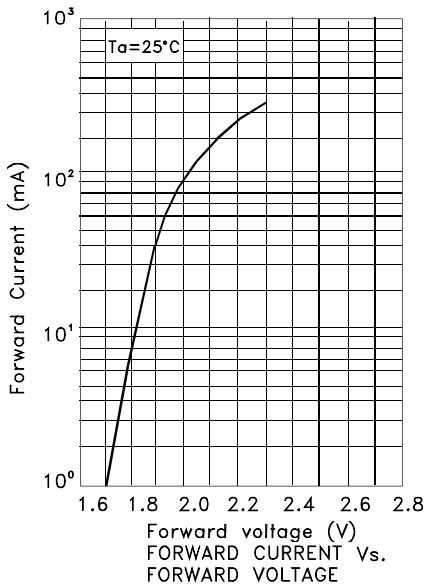
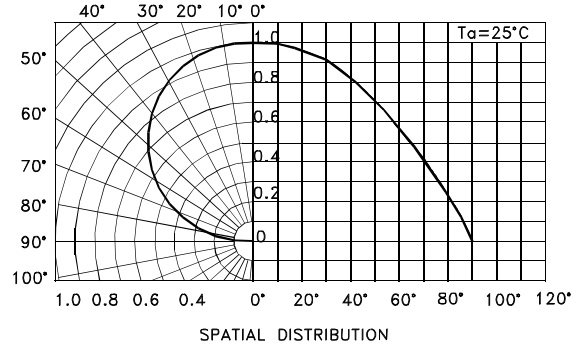
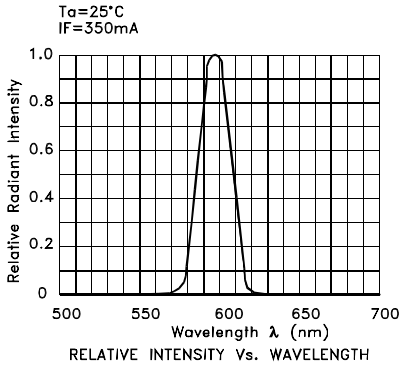
Electrical / Optical Characteristics at T_A = 25°C

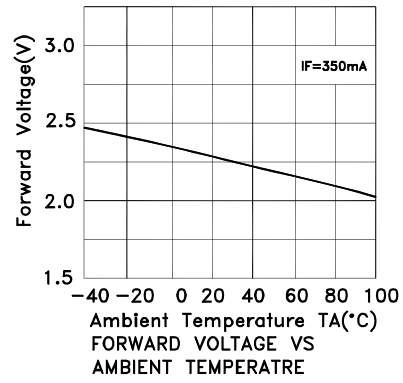
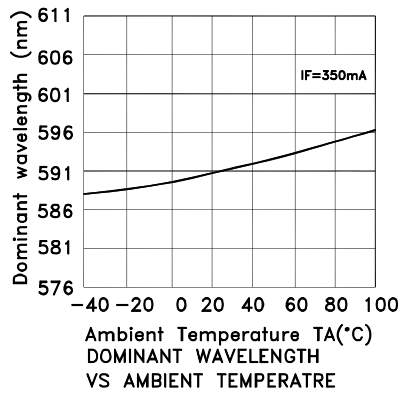
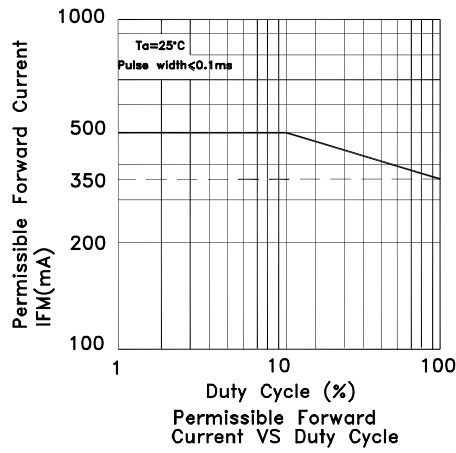
Parameter	Symbol	Value	Unit
Forward Voltage I _F = 350mA [Min.]	V _F [2]	1.8	V
Forward Voltage I _F = 350mA [Typ.]		2.3	
Forward Voltage I _F = 350mA [Max.]		2.8	
Wavelength at peak emission I _F = 350mA [Typ.]	λ peak	598	nm
Dominant Wavelength I _F = 350mA [Typ.]	λ dom [1]	591	nm
Spectral bandwidth at 50% $\Phi_{REL MAX}$ I _F = 350mA [Typ.]	$\Delta\lambda$	23	nm
Temperature coefficient of λ peak I _F = 350mA, - 10 ° C ≤ T ≤ 100 ° C [Typ.]	TC λ peak	0.12	nm/°C
Temperature coefficient of λ dom I _F = 350mA, - 10 ° C ≤ T ≤ 100 ° C [Typ.]	TC λ dom	0.07	nm/°C
Temperature coefficient of V _F I _F = 350mA, - 10 ° C ≤ T ≤ 100 ° C [Typ.]	TC _v	-3.0	mV/°C

Notes:

1. Wavelength : + / -1nm.
2. Forward Voltage : + / - 0.1V.

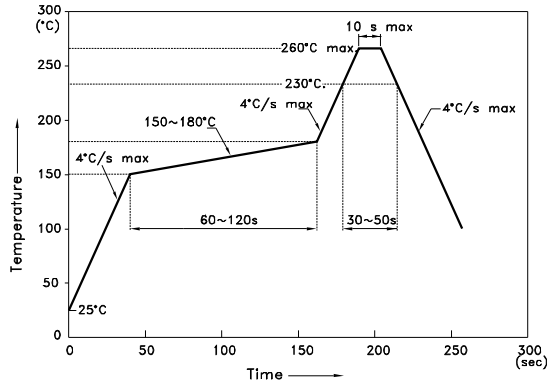
Super Bright Yellow KT-2520SY9ZS-RV





KT-2520SY9ZS-RV

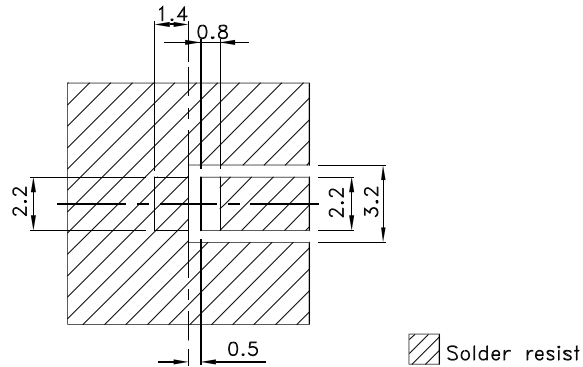
Reflow Soldering Profile For Lead-free SMT Process.



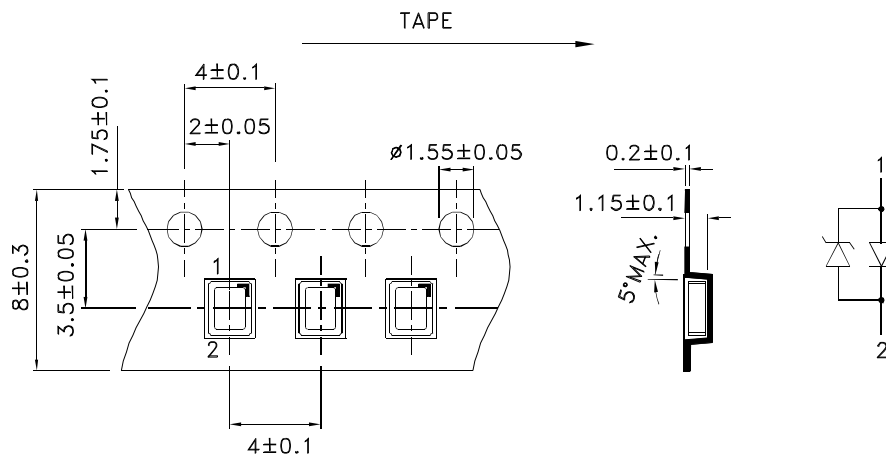
NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)

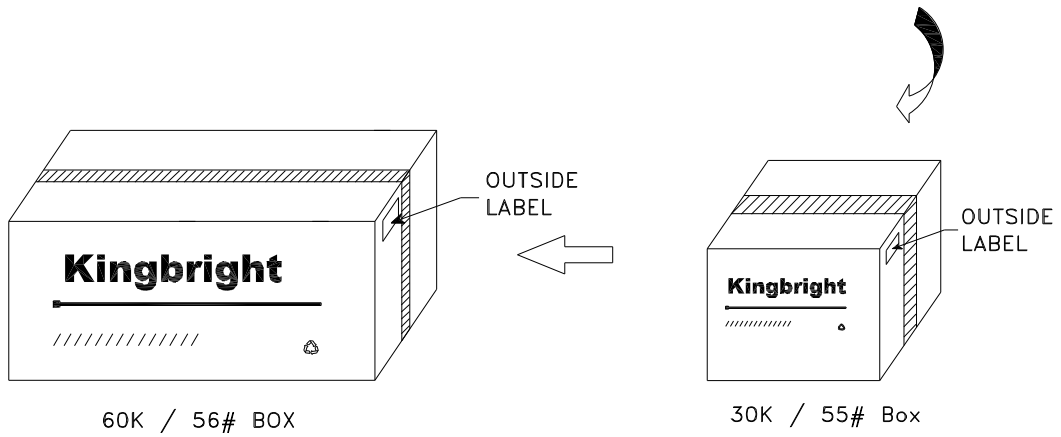
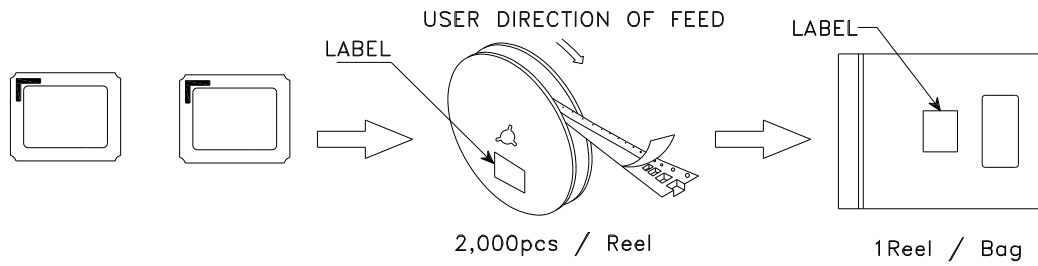



Tape Specifications (Units : mm)



PACKING & LABEL SPECIFICATIONS

KT-2520SY9ZS-RV



<h1>Kingbright</h1>	
P/NO: KT-2520xxx	
QTY: 2,000 pcs	Q.C. Q C xx-xx-xxxx PASSED
S/N: XXXX	
CODE: XXX	
LOT NO:	
 <small>XXXXXXXXXXXXXXXXXXXXXXXXXX</small>	
RoHS Compliant	